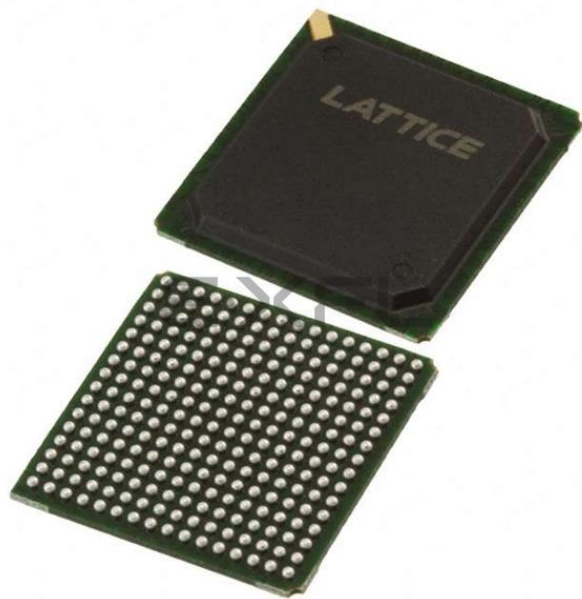




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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	5 ns
Voltage Supply - Internal	2.3V ~ 2.7V
Number of Logic Elements/Blocks	24
Number of Macrocells	768
Number of Gates	-
Number of I/O	193
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc5768mb-5f256c



Product Line	Ordering Part Number	Product Status	Reference PCN
LC5512MV	LC5512MV-45Q208C	Active / Orderable	
	LC5512MV-45QN208C		
	LC5512MV-75Q208C		
	LC5512MV-75QN208C		
	LC5512MV-75Q208I		
	LC5512MV-75QN208I		
	LC5512MV-45F256C		
	LC5512MV-45FN256C		
	LC5512MV-75F256C		
	LC5512MV-75FN256C		
	LC5512MV-75F256I		
	LC5512MV-75FN256I		
	LC5512MV-45F484C		
	LC5512MV-45FN484C		
	LC5512MV-75F484C		
	LC5512MV-75FN484C		
	LC5512MV-75F484I		
	LC5512MV-75FN484I		
LC5512MB	LC5512MB-45Q208C	Discontinued	PCN#09-10
	LC5512MB-45QN208C		
	LC5512MB-75Q208C		
	LC5512MB-75QN208C		
	LC5512MB-75Q208I		
	LC5512MB-75QN208I		
	LC5512MB-45F256C	Active / Orderable	
	LC5512MB-45FN256C		
	LC5512MB-75F256C		
	LC5512MB-75FN256C		
	LC5512MB-75F256I		
	LC5512MB-75FN256I		
	LC5512MB-45F484C	Discontinued	PCN#09-10
	LC5512MB-45FN484C		
	LC5512MB-75F484C		
	LC5512MB-75FN484C		
	LC5512MB-75F484I		
	LC5512MB-75FN484I		
LC5512MC	LC5512MC-45Q208C	Discontinued	PCN#09-10
	LC5512MC-45QN208C		
	LC5512MC-75Q208C		
	LC5512MC-75QN208C		
	LC5512MC-75Q208I		
	LC5512MC-75QN208I		
	LC5512MC-45F256C		
	LC5512MC-45FN256C		
	LC5512MC-75F256C		
	LC5512MC-75FN256C		
	LC5512MC-75F256I		
	LC5512MC-75FN256I		



Product Line	Ordering Part Number	Product Status	Reference PCN
LC5512MC (Cont'd)	LC5512MC-45F484C	Discontinued	PCN#09-10
	LC5512MC-45FN484C		
	LC5512MC-75F484C		
	LC5512MC-75FN484C		
	LC5512MC-75F484I		
	LC5512MC-75FN484I		
LC5768MV	LC5768MV-5F256C	Active / Orderable	
	LC5768MV-5FN256C		
	LC5768MV-75F256C		
	LC5768MV-75FN256C		
	LC5768MV-75F256I		
	LC5768MV-75FN256I		
	LC5768MV-5F484C		
	LC5768MV-5FN484C		
	LC5768MV-75F484C		
	LC5768MV-75FN484C		
	LC5768MV-75F484I		
	LC5768MV-75FN484I		
	LC5768MB-5F256C	Discontinued	PCN#09-10
LC5768MB	LC5768MB-5FN256C		
	LC5768MB-75F256C		
	LC5768MB-75FN256C		
	LC5768MB-75F256I		
	LC5768MB-75FN256I		
	LC5768MB-5F484C		
	LC5768MB-5FN484C		
	LC5768MB-75F484C		
	LC5768MB-75FN484C		
	LC5768MB-75F484I		
	LC5768MB-75FN484I		
LC5768MC	LC5768MC-5F256C	Discontinued	PCN#09-10
	LC5768MC-5FN256C		
	LC5768MC-75F256C		
	LC5768MC-75FN256C		
	LC5768MC-75F256I		
	LC5768MC-75FN256I		
	LC5768MC-5F484C		
	LC5768MC-5FN484C		
	LC5768MC-75F484C		
	LC5768MC-75FN484C		
	LC5768MC-75F484I		
	LC5768MC-75FN484I		

Figure 1. ispXPLD 5000MX Block Diagram



Introduction

The ispXPLD 5000MX family represents a new class of device, referred to as the eXpanded Programmable Logic Devices (XPLDs). These devices extend the capability of Lattice's popular SuperWIDE ispMACH 5000 architecture by providing flexible memory capability. The family supports single- or dual-port SRAM, FIFO, and ternary CAM operation. Extra logic has also been included to allow efficient implementation of arithmetic functions. In addition, sysCLOCK PLLs and sysIO interfaces provide support for the system-level needs of designers.

The devices provide designers with a convenient one-chip solution that provides logic availability at boot-up, design security, and extreme reconfigurability. The use of advanced process technology provides industry-leading performance with combinatorial propagation delay as low as 4.0ns, 2.8ns clock-to-out delay, 2.2ns set-up time, and operating frequency up to 300MHz. This performance is coupled with low static and dynamic power consumption. The ispXPLD 5000MX architecture provides predictable deterministic timing.

The availability of 3.3, 2.5 and 1.8V versions of these devices along with the flexibility of the sysIO interface helps users meet the challenge of today's mixed voltage designs. Inputs can be safely driven up to 5.5V when an I/O bank is configured for 3.3V operation, making this family 5V tolerant. Boundary scan testability further eases integration into today's complex systems. A variety of density and package options increase the likelihood of a good fit for a particular application. Table 1 shows the members of the ispXPLD 5000MX family.

Architecture

The ispXPLD 5000MX devices consist of Multi-Function Blocks (MFBs) interconnected with a Global Routing Pool. Signals enter and leave the device via one of four sysIO banks. Figure 1 shows the block diagram of the ispXPLD

Cascading For Wide Operation

In several modes it is possible to cascade adjacent MFBs to support wider operation. Table 2 details the different cascading options. There are chains of MFBs in each device which determine those MFBs that are adjacent for the purposes of cascading. Table 3 indicates these chains. The ispXPLD 5000MX design tools automatically cascade blocks if required by a particular design.

Table 2. Cascading Modes For Wide Support

Mode	Cascading Function
Logic	Input Width. Allows two MFBs to act as a 136-input block.
	Arithmetic. Allow the carry chain to pass between two MFBs.
FIFO	Memory Width Expansion. Allows MFBs to be cascaded for greater width support.
CAM	Memory Width Expansion. Allows up to four MFBs to be cascaded for greater width support.

Table 3. MFB Cascade Chain

Device	MFBs in Cascade Chain
ispXPLD 5256MX	A → B → C → D
	H → G → F → E
ispXPLD 5512MX	A → B → C → D → E → F → G → H
	P → O → N → M → L → K → J → I
ispXPLD 5768MX	D → C → B → A → X → W → V → U → T → S → R → Q
	E → F → G → H → I → J → K → L → M → N → O → P
ispXPLD 51024MX	H → G → F → E → D → C → B → A → AF → AE → AD → AC → AB → AA → Z → Y
	I → J → K → L → M → N → O → P → Q → R → S → T → U → V → W → X

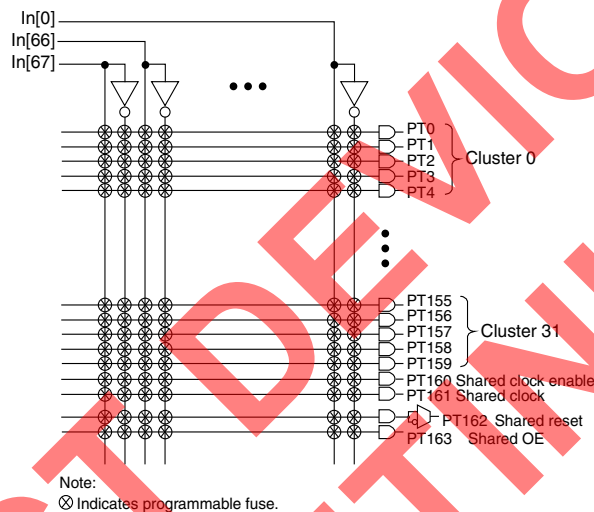
SuperWIDE Logic Mode

In logic mode, each MFB contains 32 macrocells and a fully populated, programmable AND-array with 160 logic product terms and four control product terms. The MFB has 68 inputs from the Global Routing Pool, which are available in both true and complement form for every product term. It is also possible to cascade adjacent MFBs to create a block with 136 inputs. The four control product terms are used for shared reset, clock, clock enable, and output enable functions. Figure 3 shows the overall structure of the MFB in logic mode while Figure 4 provides a more detailed view from the perspective of a macrocell slice.

AND-Array

The programmable AND-Array consists of 68 inputs and 164 output product terms. The 68 inputs from the GRP are used to form 136 lines in the AND-Array (true and complement of the inputs). Each line in the array can be connected to any of the 164 output product terms via a wired AND. Each of the 160 logic product terms feed the Dual-OR Array with the remaining four control product terms feeding the Shared PT Clock, Shared PT Clock Enable, Shared PT Reset and Shared PT OE. Starting with PT0 sets of five product terms form product term clusters. There is one product term cluster for every macrocell in the MFB. In addition to the four control product terms, the first, third, fourth and fifth product terms of each cluster can be used as a PTOE, PT Clock, PT Preset and PT Reset, respectively. Figure 5 is a graphical representation of the AND-Array.

Figure 5. AND Array



Dual-OR Array (Including Arithmetic Support)

The Dual-OR Array consists of 64 OR gates. There are two OR gates per macrocell in the MFB. These OR gates are referred to as the Expandable PTSA OR gate and the PTSA-Bypass OR gate. The PTSA-Bypass OR gate receives its five inputs from the combination of product terms associated with the product term cluster. The PTSA-Bypass OR gate feeds the macrocell directly for fast narrow logic. The Expandable PTSA OR gate receives five inputs from the combination of product terms associated with the product term cluster. It also receives an additional input from the Expanded PTSA OR gate of the N-7 macrocell, where N is the number of the macrocell associated with the current OR gate. The Expandable PTSA OR gate feeds the PTSA for sharing with other product terms and the N+7 Expandable PTSA OR gate. This allows cascading of multiple OR gates for wide functions. There is a small timing adder for each level of expansion. Figure 6 is a graphical representation of the Dual-OR Array.

The Dual-OR PT sharing array also contains logic to aid in the efficient implementation of arithmetic functions. This logic takes Carry In and allows the generation of Carry Out along with a SUM signal. Subtractors can be implemented using the two's complement method. Carry is propagated from macrocells 0 to macrocell 31. Macrocell zero can have its carry input connected to the carry output of macrocell 31 in an adjacent MFB or it can be set to zero or one. If a macrocell is not used in an arithmetic function carry can bypass it. The carry chain flows is the same as that for PT cascading.

Pseudo Dual-Port SRAM Mode

In Pseudo Dual-Port SRAM Mode the multi-function array is configured as a SRAM with an independent read and write ports that access the same 16,384-bits of memory. Data widths of 1, 2, 4, 8, 16 and 32 are supported by the MFB. Figure 10 shows the block diagram of the Pseudo Dual-Port SRAM.

Write data, write address, chip select and write enable signals are always synchronous (registered). The read data and read address signals can be synchronous or asynchronous. Reset is asynchronous. All write signals share the same clock, and clock enable. All read signals share the same clock and clock enable. Reset is shared by both read and write signals. Table 6 shows the possible sources for the clock, clock enable and initialization signals for the various registers.

Figure 10. Pseudo Dual-Port SRAM Block Diagram

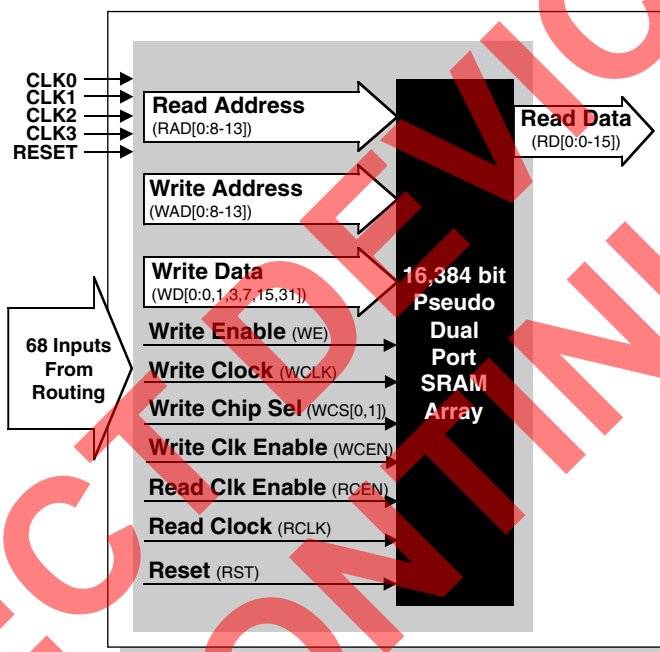


Table 6. Register Clock, Clock Enable, and Reset in Pseudo Dual-Port SRAM Mode

Register	Input	Source
Write Address, Write Data, Write Enable, and Write Chip Select	Clock	WCLK or one of the global clocks (CLK0 - CLK3). The selected signal can be inverted if desired.
	Clock Enable	WCEN or one of the global clocks (CLK1 - CLK2). The selected signal can be inverted if desired.
	Reset	Created by the logical OR of the global reset signal and RST. RST may have inversion if desired.
Read Data and Read Address	Clock	RCLK or one of the global clocks (CLK0 - CLK3). The selected signal can be inverted if desired.
	Clock Enable	RCEN or one of the global clocks (CLK1 - CLK2). The selected signal can be inverted if desired.
	Reset	Created by the logical OR of the global reset signal and RST. RST may have inversion if desired.

Supply Current

Symbol	Parameter	Condition	Min.	Typ. ³	Max.	Units
ispXPLD 5256						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	26	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	26	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	16	—	mA
I_{CCO}	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{ unloaded}$	—	3	—	mA
I_{CCP}	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
I_{CCJ}	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA
ispXPLD 5512						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	33	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	33	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	22	—	mA
I_{CCO}	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{ unloaded}$	—	3	—	mA
I_{CCP}	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
I_{CCJ}	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA
ispXPLD 5768						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	40	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	40	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	30	—	mA
I_{CCO}	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{ unloaded}$	—	3	—	mA
I_{CCP}	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
I_{CCJ}	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA

Supply Current (Continued)

Symbol	Parameter	Condition	Min.	Typ. ³	Max.	Units
ispXPLD 51024						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	75	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	75	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	55	—	mA
I_{CCO}	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{ unloaded}$	—	3	—	mA
I_{CCP}	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
I_{CCJ}	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA

1. Device configured with 16-bit counters.

2. I_{CC} varies with specific device configuration and operating frequency.3. $T_A = 25^\circ C$

ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{FIFOWES}	Write-Enable setup before Write Clock	—	2.33	—	2.33	—	2.91	—	2.91	—	3.03	—	ns
t _{FIFOWEH}	Write-Enable hold after Write Clock	—	-2.95	—	-2.95	—	-2.36	—	-2.36	—	-2.27	—	ns
t _{FIFORES}	Read-Enable setup before Read Clock	—	2.69	—	2.35	—	2.79	—	2.38	—	4.14	—	ns
t _{FIFOREH}	Read-Enable hold after Read Clock	—	-3.17	—	-3.17	—	-2.53	—	-2.53	—	-2.44	—	ns
t _{FIFORSTO}	Reset to Output Delay	—	—	3.30	—	3.30	—	4.13	—	4.13	—	4.29	ns
t _{FIFORSTR}	Reset Recovery Time	—	1.20	—	1.20	—	1.50	—	1.50	—	1.56	—	ns
t _{FIFORSTPW}	Reset Pulse Width	—	0.14	—	0.14	—	0.18	—	0.18	—	0.19	—	ns
t _{FIFORCLKO}	Read Clock to FIFO Out Delay	—	—	3.73	—	3.73	—	4.66	—	4.66	—	4.84	ns
CAM – Update Mode													
t _{CAMMSS}	Memory Select Setup before CLK	—	1.40	—	0.70	—	1.50	—	1.40	—	1.44	—	ns
t _{CAMMSH}	Memory Select Hold after CLK	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMENMSKS}	Enable Mask Register Setup Time before CLK	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMENMSKH}	Enable Mask Register Setup Time after CLK	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMADDS}	Address Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMADDH}	Address Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMDATAS}	Data Setup Time before Clock	—	-0.41	—	-0.41	—	-0.33	—	-0.33	—	-0.31	—	ns
t _{CAMDATAH}	Data Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMDACS}	“Don’t Care” Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMDCH}	“Don’t Care” Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMRWS}	R/W Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMRWH}	R/W Enable Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMCES}	Clock Enable Setup Time before Clock	—	1.55	—	1.55	—	1.94	—	1.94	—	2.02	—	ns
t _{CAMCEH}	Clock Enable Hold Time after Clock	—	-2.95	—	-2.95	—	-2.36	—	-2.36	—	-2.27	—	ns

ispXPLD 5000MX Family Timing Adders

Parameter	Description	Base Param.	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{IOI} Input Adjusters													
LVTTTL_in	Using 3.3V TTL	t _{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVC MOS_18_in	Using 1.8V CMOS	t _{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVC MOS_25_in	Using 2.5V CMOS	t _{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVC MOS_33_in	Using 3.3V CMOS	t _{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
AGP_1X_in	Using AGP 1x	t _{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t _{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t _{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t _{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
HSTL_IV_in	Using HSTL 2.5V, Class IV	t _{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVDS_in	Using Low Volt- age Differential Signaling (LVDS)	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
LVPECL_in	Using Low Voltage PECL	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
PCI_in	Using PCI	t _{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t _{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t _{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
t _{IOO} Output Adjusters – Output Signal Modifiers													
Slow Slew	Using Slow Slew (LVTTTL and LVC MOS Outputs Only)	t _{IOBUF} , t _{IOEN}	—	0.9	—	0.9	—	0.9	—	0.9	—	0.9	ns
t _{IOO} Output Adjusters – Output Configurations													
LVTTTL_out	Using 3.3V TTL Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	1.2	—	1.2	—	1.2	—	1.2	—	1.2	ns
LVC MOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
LVC MOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
3	34N	E30	-	-	E31	H14
3	34P	E28	-	-	E29	G16
3	35N	E26	-	-	E27	G15
3	35P	E24/PLL_FBK1	-	-	E25	F15
3	36N	E22/PLL_RST1	E27	F27	E23	H12
3	36P	E21	E26	F26	-	G14
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	37N	E20	E25	F25	-	F16
-	-	VCCO3	-	-	-	VCCO3
3	37P	E18	E24	F24	E19	E16
-	-	GND	-	-	-	GND
3	38N	E16	E23	F23	E17	G13
3	38P	E14	E22	F22	E15	G12
3	39N	E12	E21	F21	E13	F14
3	39P	E10/CLK_OUT1	E20	F20	E11	E15
-	-	VCC	-	-	-	VCC
3	40N	E8	E19	F19	E9	D12
3	40P	E6	E18	F18	E7	B14
3	41N	E5	E17	F17	-	C13
3	41P	E4	E16	F16	-	A14
3	42N	E2	E31	F31	E3	A13
3	42P	E0	E30	F30	E1	B13
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
-	-	VCCO3	-	-	-	VCCO3
3	43N	F30	E15	F15	F31	B11
3	43P	F28	E14	F14	F29	C11
3	44N	F26	E13	F13	F27	B10
3	44P	F24	E12	F12	F25	A10
3	45N	F22	E11	F11	F23	C10
3	45P	F21	E10	F10	-	D10
3	46N	F20	E9	F9	-	C9
3	46P	F18	E8	F8	F19	E9
3	47N	F16/VREF3	E29	F29	F17	D9
3	47P	F14	E28	F28	F15	F9
3	48N	F12	E7	F7	F13	A9
3	48P	F10	E6	F6	F11	F8
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	49N	F8	E5	F5	F9	E8
-	-	VCCO3	-	-	-	VCCO3
3	49P	F6	E4	F4	F7	A8
3	50N	F5	E3	F3	-	B9
3	50P	F4	E2	F2	-	D8
-	-	VCC	-	-	-	VCC

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
3	51N	F2	E1	F1	F3	B8
3	51P	F0	E0	F0	F1	C8
0	52N	G30	G31	H31	G31	B7
0	52P	G28	G30	H30	G29	A7
-	-	GND	-	-	-	NC
0	53N	G26	G29	H29	G27	D7
0	53P	G24	G28	H28	G25	C7
0	54N	G22	G27	H27	G23	B6
-	-	VCCO0	-	-	-	VCCO0
0	54P	G21	G26	H26	-	E7
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)
0	55N	G20	G25	H25	-	E6
0	55P	G18	G24	H24	G19	A6
0	56N	G16/VREF0	G3	H3	G17	A5
0	56P	G14	G2	H2	G15	A4
0	57N	G12	G23	H23	G13	B5
0	57P	G10	G22	H22	G11	A3
0	58N	G8	G21	H21	G9	B4
0	58P	G6	G20	H20	G7	B3
0	59N	G5	G19	H19	-	C5
0	59P	G4	G18	H18	-	C6
0	60N	G2	G1	H1	G3	D5
0	60P	G0	G0	H0	G1	D6
-	-	VCCO0	-	-	-	VCCO0
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)

Global Clock LVDS pair options: GCLK0 and GCLK1, as well as GCLK2 and GCLK3, can be paired together to receive differential clocks; where GCLK0 and GCLK3 are the positive LVDS inputs

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
—	—	V _{CCO2}	—	—	—	85	V _{CCO2}	V _{CCO2}
2	29N	E10	F5	H5	E11	86	M10	U12
—	—	GND (Bank 2)	—	—	—	87	GND (Bank 2)	GND (Bank 2)
2	30P	E12	F6	H6	E13	88	M11	AB13
2	30N	E16	F7	H7	E17	89	T13	Y13
2	31P	E18	—	—	E19	90	P11	V13
2	31N	E20/V _{REF2}	—	—	E21	91	T14	W13
2	32P	E22	F8	H8	E23	92	R12	V14
2	32N	E24	F9	H9	E25	93	R13	W14
2	33P	E26	F10	H10	E27	94	N11	Y14
2	33N	E28	F11	H11	E29	95	T15	AB14
2	34P	F0	F12	H12	F1	96	R14	AB15
2	34N	F2	F13	H13	F3	97	N12	AA15
2	35P	F4	F14	H14	F5	98	P12	U13
—	—	V _{CCO2}	—	—	—	—	V _{CCO2}	V _{CCO2}
2	35N	F6	F15	H15	F7	99	R15	U14
—	—	GND (Bank 2)	—	—	—	—	GND (Bank 2)	GND (Bank 2)
2	36P	F8	E0	—	F9	—	—	W15
2	36N	F10	E2	—	F11	—	—	W16
2	37P	F12	E4	—	F13	—	—	Y16
2	37N	F16	E6	—	F17	—	—	AA16
2	38P	F18	E8	—	F19	—	—	AB16
2	38N	F20	E10	—	F21	—	—	AA17
2	39P	F22	E12	—	F23	—	—	Y17
2	39N	F24	E16	—	F25	—	—	AA18
2	40P	F26	E20	—	F27	—	—	W17
2	40N	F28	E22	—	F29	—	—	W18
2	41P	G0	—	—	G1	—	—	V15
—	—	V _{CCO2}	—	—	—	100	V _{CCO2}	V _{CCO2}
2	41N	G2	—	—	G3	—	—	U15
—	—	GND (Bank 2)	—	—	—	101	GND (Bank 2)	GND (Bank 2)
2	42P	G4	—	—	G5	102	P13	Y18
2	42N	G6	—	—	G7	103	P15	V17
2	43P	G8	—	—	G9	—	M13	V16
2	43N	G10	—	—	G11	—	P14	U16
2	44P	G12	—	—	G13	—	—	AB18
2	44N	G14	—	—	G15	—	—	AB19
2	45P	G16	—	—	G17	—	—	U18
2	45N	G18	—	—	G19	—	—	T17
2	46P	G20	—	—	G21	104	R16	AB20
2	46N	G22	—	—	G23	105	P16	AA20
2	47P	G24	—	—	G25	106	N15	Y19
—	—	V _{CCO2}	—	—	—	107	V _{CCO2}	V _{CCO2}

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
2	29N	E2	F1	H1	E3	T12	AA12
-	-	GND	-	-	-	GND	GND
2	30P	E4	F2	H2	E5	P10	Y12
2	30N	E6	F3	H3	E7	R10	AA13
2	31P	E8	F4	H4	E9	R11	V12
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	31N	E10	F5	H5	E11	M10	U12
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	32P	E12	F6	H6	E13	M11	AB13
2	32N	E14	F7	H7	E15	T13	Y13
2	33P	E16	H0	-	E17	P11	V13
2	33N	E18/VREF2	H1	-	E19	T14	W13
2	34P	E20	F8	H8	E21	R12	V14
2	34N	E22	F9	H9	E23	R13	W14
2	35P	E24	F10	H10	E25	N11	Y14
2	35N	E26	F11	H11	E27	T15	AB14
2	36P	E28	F12	H12	E29	R14	AB15
2	36N	E30	F13	H13	E31	N12	AA15
2	37P	F0	F14	H14	F1	P12	U13
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	37N	F2	F15	H15	F3	R15	U14
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	38P	F4	H2	E0	F5	—	W15
2	38N	F6	H3	E2	F7	—	W16
2	39P	F8	H4	E4	F9	—	Y16
2	39N	F10	H5	E6	F11	—	AA16
2	40P	F12	H6	E8	F13	—	AB16
2	40N	F14	H7	E10	F15	—	AA17
2	41P	F16	H8	E12	F17	—	Y17
2	41N	F18	H9	E16	F19	—	AA18
2	42P	F20	H10	E20	F21	—	W17
-	-	VCC	-	-	-	VCC	VCC
2	42N	F22	H11	E22	F23	—	W18
-	-	GND	-	-	-	GND	GND
2	43P	F24	H12	-	F25	—	V15
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	43N	F26	H13	-	F27	—	U15
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	44P	F28	H14	-	F29	P13	Y18
2	44N	F30	H15	-	F31	P15	V17
2	45P	G0	H16	-	G1	M13	V16
2	45N	G2	H17	-	G3	P14	U16
2	46P	G4	H18	-	G5	—	AB18

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
2	46N	G6	H19	-	G7	—	AB19
2	47P	G8	H20	-	G9	—	AA19
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	47N	G10	H21	-	G11	—	U17
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	48P	G12	H22	-	G13	—	V18
2	48N	G14	H23	-	G15	—	AB21
2	49P	G16	H24	-	G17	—	U18
2	49N	G18	H25	-	G19	—	T17
2	50P	G20	H26	-	G21	R16	AB20
2	50N	G22	H27	-	G23	P16	AA20
2	51P	G24	H28	-	G25	N15	Y19
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	51N	G26	H29	-	G27	N14	V19
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	52P	G28	F16	H16	G29	N16	T18
2	52N	G30	F17	H17	G31	M16	R17
2	53P	H0	F18	H18	H1	M14	U19
2	53N	H2	F19	H19	H3	M15	T19
2	54P	H4	H30	E24	H5	—	V20
-	-	VCC	-	-	-	VCC	VCC
2	54N	H6	H31	E26	H7	—	U20
2	55P	H8	F20	H20	H9	L13	W20
2	55N	H10	F21	H21	H11	L12	Y21
2	56P	H12	F22	H22	H13	L15	R18
2	56N	H14	F23	H23	H15	L16	R19
-	-	GND	-	-	-	GND	GND
2	57P	H16	F24	H24	H17	L14	W21
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	57N	H18	F25	H25	H19	K15	Y22
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	58P	H20	F26	H26	H21	K14	R20
2	58N	H22	F27	H27	H23	K12	P20
2	59P	H24	F28	H28	H25	K13	T21
2	59N	H26	F29	H29	H27	J13	R21
2	60P	H28	F30	H30	H29	J14	U21
2	60N	H30	F31	H31	H31	J12	V21
-	-	TOE	-	-	-	J15	W22
-	-	RESET	-	-	-	J11	V22
-	-	GOE0	-	-	-	H11	T22
-	-	GOE1	-	-	-	H13	R22
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table	

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	VCC	-	-	-	VCC	VCC
0	109P	Q28	Q30	S30	Q29	A7	C11
-	-	GND	-	-	-	GND	GND
0	110N	Q26	Q29	S29	Q27	D7	B11
0	110P	Q24	Q28	S28	Q25	C7	A11
0	111N	Q22	Q27	S27	Q23	B6	F11
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	111P	Q20	Q26	S26	Q21	E7	F10
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	112N	Q18	Q25	S25	Q19	E6	E10
0	112P	Q16	Q24	S24	Q17	A6	C10
0	113N	Q14/VREF0	Q3	S3	Q15	A5	D10
0	113P	Q12	Q2	S2	Q13	A4	B10
0	114N	Q10	Q23	S23	Q11	B5	A10
0	114P	Q8	Q22	S22	Q9	A3	A9
0	115N	Q6	Q21	S21	Q7	B4	C9
0	115P	Q4	Q20	S20	Q5	B3	D9
0	116N	Q2	Q19	S19	Q3	C5	F9
0	116P	Q0	Q18	S18	Q1	C6	E9
0	117N	R30	Q1	S1	R31	D5	A8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	117P	R28	Q0	S0	R29	D6	B8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	118N	R26	S29	-	R27	—	A7
0	118P	R24	S28	-	R25	—	B7
0	119N	R22	S27	-	R23	—	A5
0	119P	R20	S26	-	R21	—	B5
0	120N	R18	S25	-	R19	—	B6
0	120P	R16	S24	-	R17	—	C7
0	121N	R14	S23	-	R15	—	E8
0	121P	R12	S22	-	R13	—	E7
0	122N	R10	S21	-	R11	—	E6
-	-	VCC	-	-	-	VCC	VCC
0	122P	R8	S20	-	R9	—	D6
-	-	GND	-	-	-	GND	GND
0	123N	R6	S19	-	R7	—	D8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	123P	R4	S18	-	R5	—	F8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	124N	R2	S17	-	R3	—	F7
0	124P	R0	S16	-	R1	—	D7
0	125N	S30	S15	-	S31	A2	C6
0	125P	S28	S14	-	S29	B2	C5

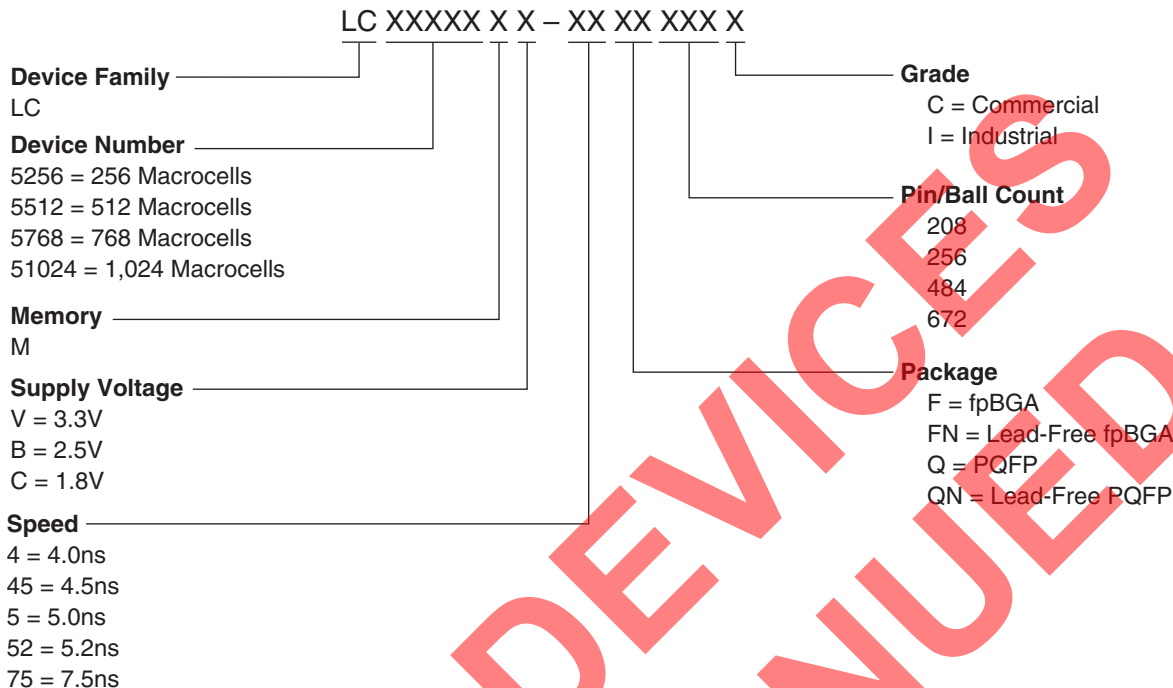
ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
2	63P	K8	L20	-	K9	AA19	AA18
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	63N	K10	L21	-	K11	U17	Y18
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	64P	K12	L22	-	K13	V18	AD25
2	64N	K14	L23	-	K15	AB21	AD26
2	65P	K16	L24	-	K17	U18	AC23
2	65N	K18	L25	-	K19	T17	AC24
2	66P	K20	L26	-	K21	AB20	AC25
2	66N	K22	L27	-	K23	AA20	AC26
2	67P	K24	L28	-	K25	Y19	AB22
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	67N	K26	L29	-	K27	V19	AB23
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	68P	K28	J16	L16	K29	T18	AB24
2	68N	K30	J17	L17	K31	R17	AB25
2	69P	L0	J18	L18	L1	U19	AB26
2	69N	L2	J19	L19	L3	T19	AA26
2	70P	L4	L30	L24	L5	V20	AA22
-	-	VCC	-	-	-	VCC	VCC
2	70N	L6	L31	L26	L7	U20	Y21
2	71P	L8	J20	L20	L9	W20	AA23
2	71N	L10	J21	L21	L11	Y21	AA24
2	72P	L12	J22	L22	L13	R18	AA25
2	72N	L14	J23	L23	L15	R19	Y26
-	-	GND	-	-	-	GND	GND
2	73P	L16	J24	L24	L17	W21	Y22
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	73N	L18	J25	L25	L19	Y22	Y23
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	74P	L20	J26	L26	L21	R20	W20
2	74N	L22	J27	L27	L23	P20	V20
2	75P	L24	J28	L28	L25	T21	W21
2	75N	L26	J29	L29	L27	R21	V21
2	76P	L28	J30	L30	L29	U21	Y24
2	76N	L30	J31	L31	L31	V21	Y25
2	77P	N0	P0	N0	N1	—	W22
2	77N	N2	P1	N1	N3	—	W23
2	78P	N4	P2	N2	N5	—	W24
-	-	VCC	-	-	-	VCC	VCC
2	78N	N6	P3	N3	N7	—	W25
-	-	GND	-	-	-	GND	GND
2	79P	N8	P4	N4	N9	—	W26

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	79N	N10	P5	N5	N11	—	V26
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	80P	N12	P6	N6	N13	—	V22
2	80N	N14	P7	N7	N15	—	V23
2	81P	N16	P8	N8	N17	—	V24
2	81N	N18	P9	N9	N19	—	V25
2	82P	N20	P10	N10	N21	—	U20
2	82N	N22	P11	N11	N23	—	T20
2	83P	N24	P12	N12	N25	—	U26
2	83N	N26	P13	N13	N27	—	U25
2	84P	N28	P14	N14	N29	—	U21
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	84N	N30	P15	N15	N31	—	T21
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	85P	P0	P16	N16	P1	—	U22
2	85N	P2	P17	N17	P3	—	U23
2	86P	P4	P18	N18	P5	—	U24
2	86N	P6	P19	N19	P7	—	T24
2	87P	P8	P20	N20	P9	—	T23
2	87N	P10	P21	N21	P11	—	T22
2	88P	P12	P22	N22	P13	—	T25
-	-	VCC	-	-	-	VCC	VCC
2	88N	P14	P23	N23	P15	—	R26
-	-	GND	-	-	-	GND	GND
2	89P	P16	P24	N24	P17	—	R25
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	89N	P18	P25	N25	P19	—	R24
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	90P	P20	P26	N26	P21	—	R21
2	90N	P22	P27	N27	P23	—	P21
2	91P	P24	P28	N28	P25	—	R22
2	91N	P26	P29	N29	P27	—	R23
2	92P	P28	P30	N30	P29	—	R20
2	92N	P30	P31	N31	P31	—	P20
-	-	TOE	-	-	-	W22	P25
-	-	RESET	-	-	-	V22	P24
-	-	GOE0	-	-	-	T22	P23
-	-	GOE1	-	-	-	R22	P22
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table	
-	GCLK3N	GCLK2	-	-	-	P16	N26
-	-	VCCP	-	-	-	See Power Supply and NC Connections Table	

Part Number Description



Ordering Information

Note: For voltage families offered in industrial temperature grades and for all but the slowest commercial speed grade, the speed grades on these devices are dual marked. For example, the commercial speed grade -45XXXXC is also marked with the industrial grade -75I. The commercial grade is always one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade is marked as commercial grade only. In addition, the fastest commercial speed grade (-5) for the LC5768MB/MV devices, at Lattice's discretion, will utilize either a commercial grade only single-mark or a dual-mark format in conjunction with the slower industrial speed grade (-75).

Conventional Packaging

ispXPLD 5000MC (1.8V) Commercial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MC	LC5256MC-4F256C	256	1.8	4.0	fpBGA	256	141	C
	LC5256MC-5F256C	256	1.8	5.0	fpBGA	256	141	C
	LC5256MC-75F256C	256	1.8	7.5	fpBGA	256	141	C
LC5512MC	LC5512MC-45Q208C	512	1.8	4.5	PQFP	208	149	C
	LC5512MC-75Q208C	512	1.8	7.5	PQFP	208	149	C
	LC5512MC-45F256C	512	1.8	4.5	fpBGA	256	193	C
	LC5512MC-75F256C	512	1.8	7.5	fpBGA	256	193	C
	LC5512MC-45F484C	512	1.8	4.5	fpBGA	484	253	C
	LC5512MC-75F484C	512	1.8	7.5	fpBGA	484	253	C

Revision History

Date	Version	Change Summary
—	—	Previous Lattice releases.
December 2003	07	Added ispXPLD 5768MX information (supply current, timings, power consumption, power estimation coefficients, memory coefficients, logic signal connections, ordering part numbers).
		Updated ispXPLD 5000MX timing numbers (version v.1.7).
		Added lead-free package designator.
		Removed ispXPLD 5000MC industrial temperature grade ordering part numbers.
January 2004	08	Lead-free package release for the ispXPLD 5000MC and 5000MV devices.
		Timing model parameter tCOi correction - Maximum specification instead of Minimum (no changes in the timing numbers).
March 2004	08.1	Updated the MFB Cascade Chain table for the ispXPLD 5256MX device.
May 2004	09	Updated the ispXPLD 5000MX timing numbers (version v.1.8)
		ispXPLD 5256MC, 5512MC and 51024MC industrial temperature grade devices release
		Updated typical supply current data and condition.
August 2004	10	ispXPLD 5256MX 256-fpBGA logic signal connection tables: Removed internal signal description for ball H5 and G14.
		Added footnote "1, page 49. These inputs should not toggle during power up for proper power-up configuration." to CCLK and READ.
October 2004	10.1	Added ispXPLD 5768MC Industrial grade OPNs (Conventional and Lead-Free).
October 2004	10.1	Figure 19, LVPECL Driver with Three Resistor Pack has been updated (ispXPLD LVPECL Buffer changed to ispXPLD Emulated LVPECL Buffer)
November 2004	11	Added ispXPLD 5000MB (2.5V) Lead-Free Ordering Part Numbers.
December 2004	11.1	Pin name RESETB has been updated to RESET.
March 2005	12	208-PQFP Lead-free package release for the ispXPLD 5512MV/B/C devices.
April 2005	12.1	Page 23, clarification of footnote regarding IDK specification.
March 2006	12.2	Signal description for RESET has been updated.
April 2009	12.3	Ordering Information section has been updated to describe alternate LC5768MB/MV top side marking format.
February 2010	12.4	References to "system gates" changed to "functional gates."